TWS30XX(ZC) Series

DIP6, DC Input, Zero-Cross Photo TRIAC Coupler

Description

The TWS303X,TWS304X and TWS306X and TWS308X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon zero-cross photo triac in a plastic DIP6 package with different lead forming options.

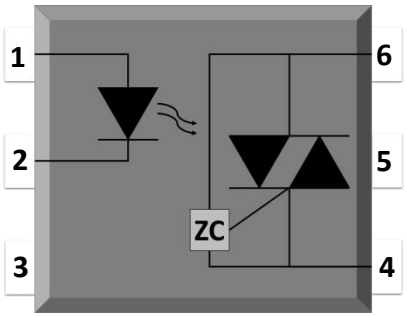
Features

- High isolation 5000 VRMS
- DC input with zero-cross photo triac output
- Operating temperature range - 40 °C to 100 °C
- REACH & RoHS compliance
- MSL class 1

Applications

- Solenoid/valve controls
- Lighting controls
- Motor controls
- Temperature controls
- Static AC power switches
- Solid state relays
- Interfacing microprocessors to 115 to 240VAC peripherals

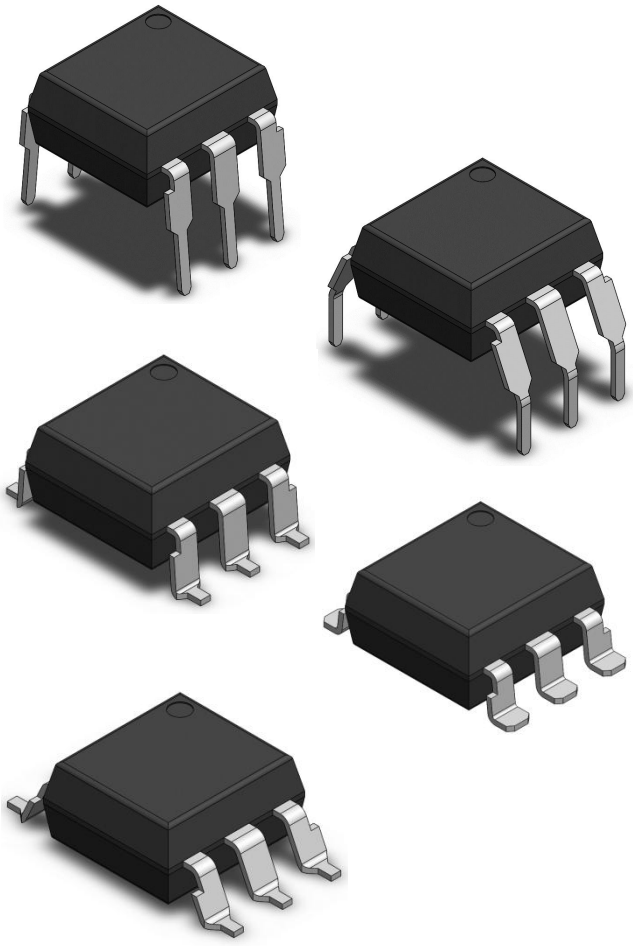
SCHEMATIC



PIN DEFINITION

1. Anode
2. Cathode
3. NC
4. Terminal
5. Substrate
6. Terminal

PACKAGE OUTLINE



ABSOLUTE MAXIMUM RATINGS					
PARAMETER		SYMBOL	VALUE	UNIT	NOTE
INPUT					
Forward Current		I_F	60	mA	
Reverse Voltage		V_R	6	V	
Junction Temperature		Tj	125	°C	
Input Power Dissipation		P_I	100	mW	
OUTPUT					
Off-state Output Terminal Voltage	TWS303X	V_{DRM}	250	V	
	TWS304X		400		
	TWS306X		600		
	TWS308X		800		
Peak Repetitive Surge Current PW=100μs, 120pps		I_{TSM}	1	A	
On-State RMS Current		$I_{T(RMS)}$	100	mA	
Junction Temperature		Tj	125	°C	
Output Power Dissipation		P_O	300	mW	
COMMON					
Total Power Dissipation		Ptot	400	mW	
Isolation Voltage		Viso	5000	Vrms	1
Operating Temperature		Topr	-40~100	°C	
Storage Temperature		Tstg	-55~125	°C	
Soldering Temperature		Tsol	260	°C	2

Note 1. AC For 1 Minute, R.H. = 40 ~ 60%

Note 2. For 10 seconds

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT								
Forward Voltage		V_F	-	1.24	1.4	V	I_F=10mA	
Reverse Current		I_R	-	-	10	μA	V_R=6V	
Input Capacitance		Cin	-	8.5	250	pF	V=0, f=1kHz	
OUTPUT								
Peak Off-state Current, Either Direction		I_{DRM}	-	-	500	nA	V_{DRM}=Rated V_{DRM} I_F=0	
Peak On-state Voltage, Either Direction		V_{TM}	-	1.59	2.5	V	I_{TM}=100mA	
Critical Rate of Rise of Off-state Voltage		dV/dt	1000	-	-	V/μs	V_{PEAK} =400V, I_F =0	3
TRANSFER CHARACTERISTICS								
LED Trigger Current	TWS3031,TWS3041, TWS3061,TWS3081	I_{FT}	-	-	15	mA	Terminal Voltage = 3V I_{TM}=100mA	
	TWS3032,TWS3042, TWS3062.TWS3082		-	-	10			
	TWS3033,TWS3043, TWS3063,TWS3083		-	-	5			
Holding Current		I_H	-	237	-	μA		
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C_{IO}	-	0.4	-	pF	V=0, f=1MHz	
ZERO-CROSSING CHARACTERISTICS								
Inhibit Voltage		V_{INH}	-	-	20	V	I_F=Rated I_{FT}	
Leakage in Inhibited State		I_{DRM2}	-	-	500	μA	I_F=Rated I_{FT} V_{DRM}=Rated V_{DRM}	

Note3. Test voltage must be applied within dV/dt rating.

CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Ambient Temperature

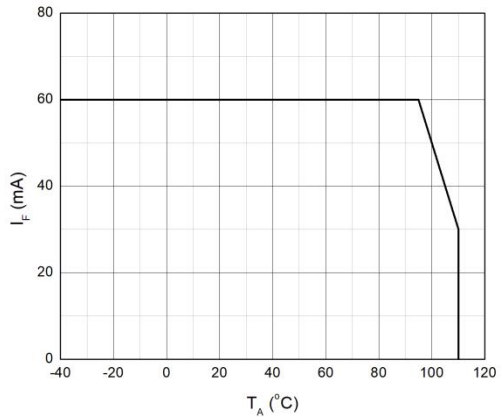


Fig.2 On-state Terminal Current vs. Ambient Temperature

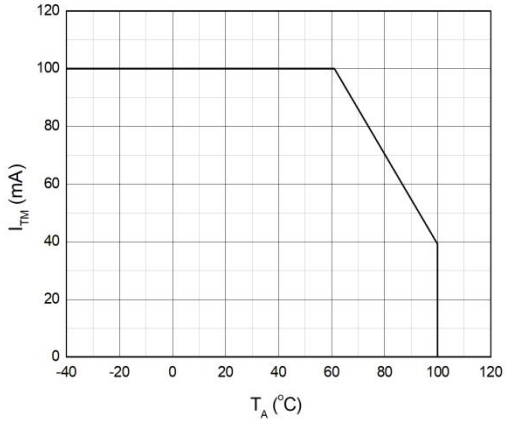


Fig.3 Forward Current vs. Forward Voltage

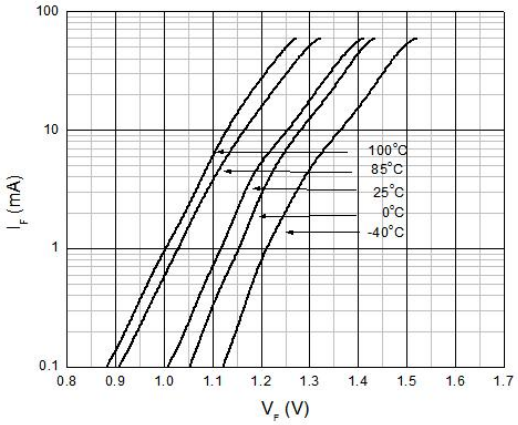


Fig.4 Off-state Terminal Current vs. Ambient Temperature

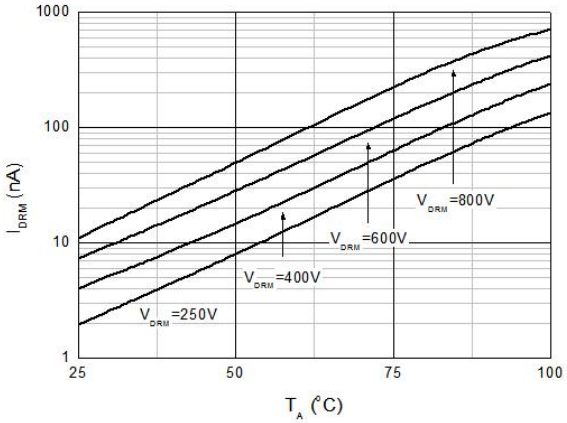


Fig.5 Normalized Off-state Terminal Voltage vs. Ambient Temperature

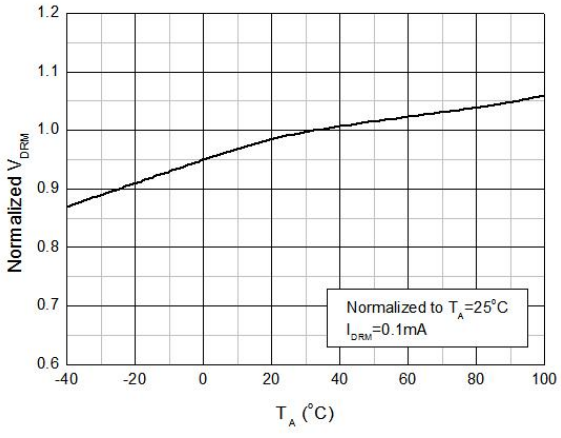
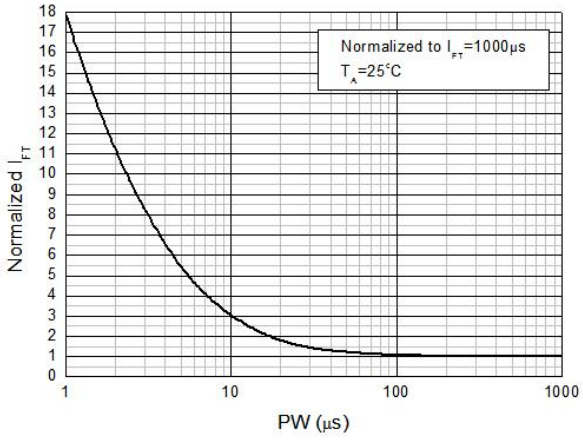


Fig.6 Normalized Trigger Current vs. LED Trigger Pulse Width



CHARACTERISTIC CURVES

Fig.7 Normalized Trigger Current vs. Ambient Temperature

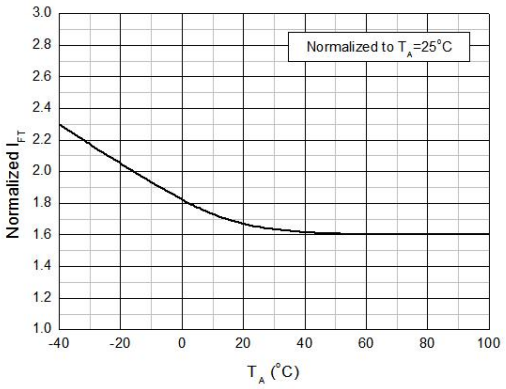


Fig.8 On-state Terminal Voltage vs. Ambient Temperature

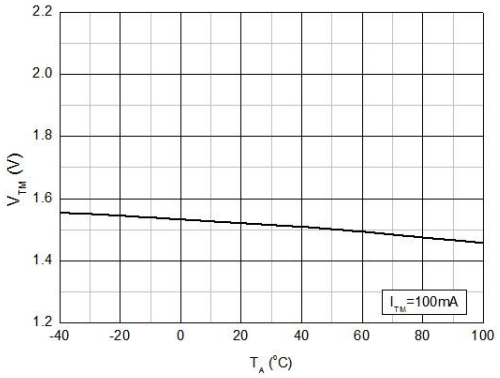


Fig.9 On-state Terminal Voltage vs. On-state Terminal Current

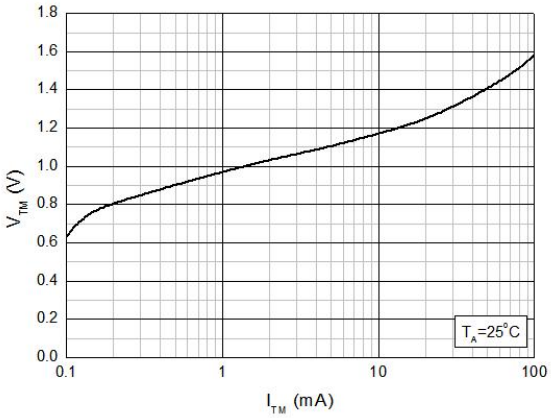


Fig.10 Holding Current vs. Ambient Temperature

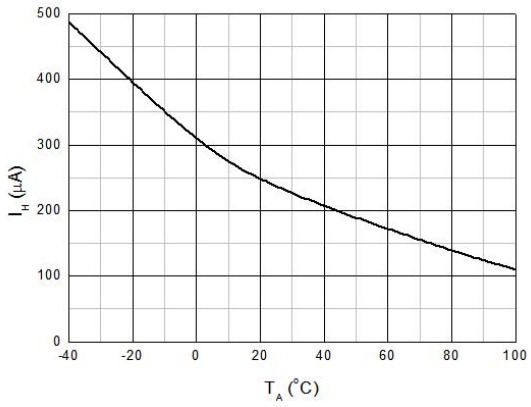


Fig.11 Normalized Inhibit Voltage vs. Ambient Temperature

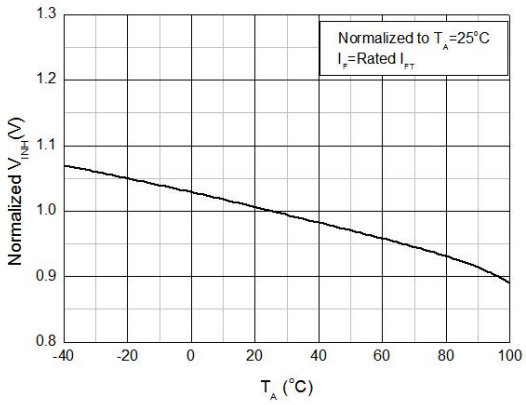
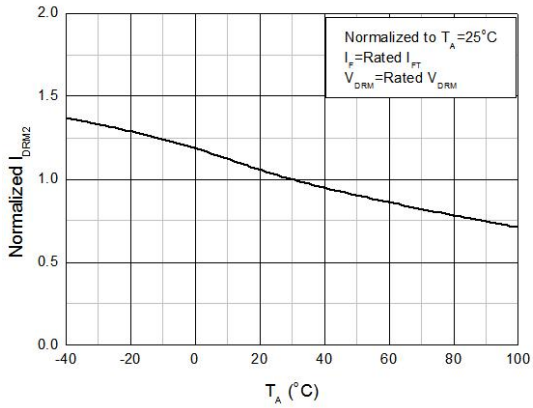


Fig.12 Normalized Leakage in Inhibit State vs. Ambient Temperature



CHARACTERISTIC CURVES

Fig.13 Turn On Time vs. Forward Current

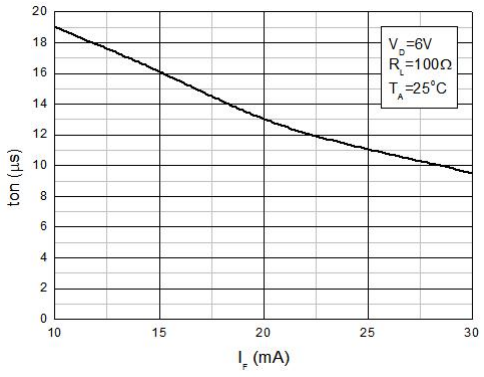
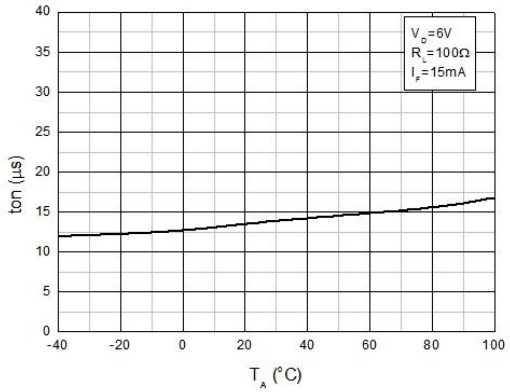


Fig.14 Turn On Time vs. Ambient Temperature



TEST CIRCUITS

Fig.15 Test Circuits of Turn On Time

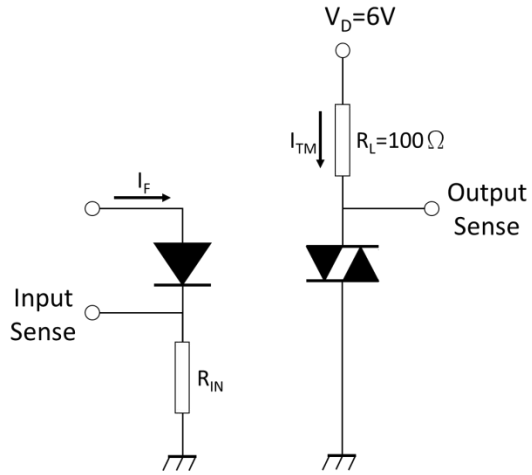


Fig.16 Waveforms of Turn On Time

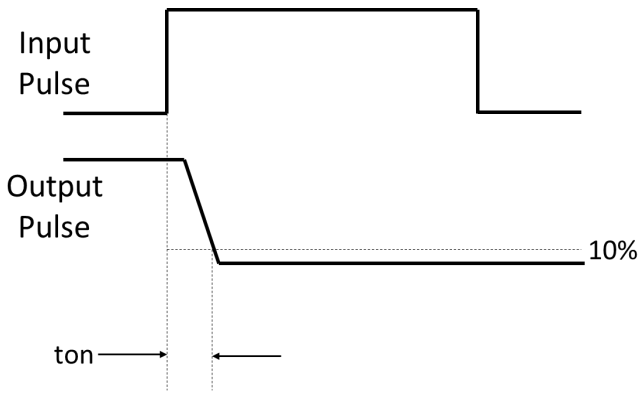


Fig.17 Test Circuits of dV/dt

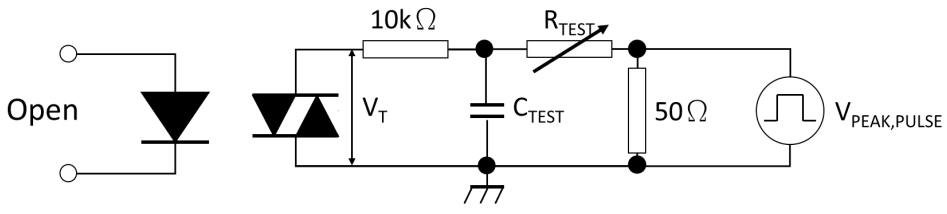
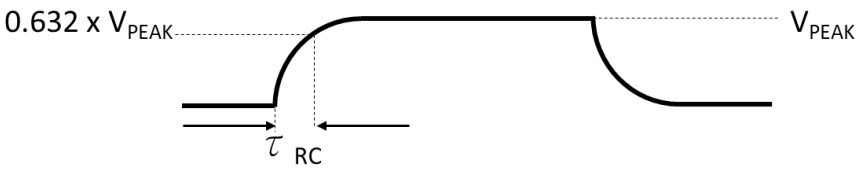


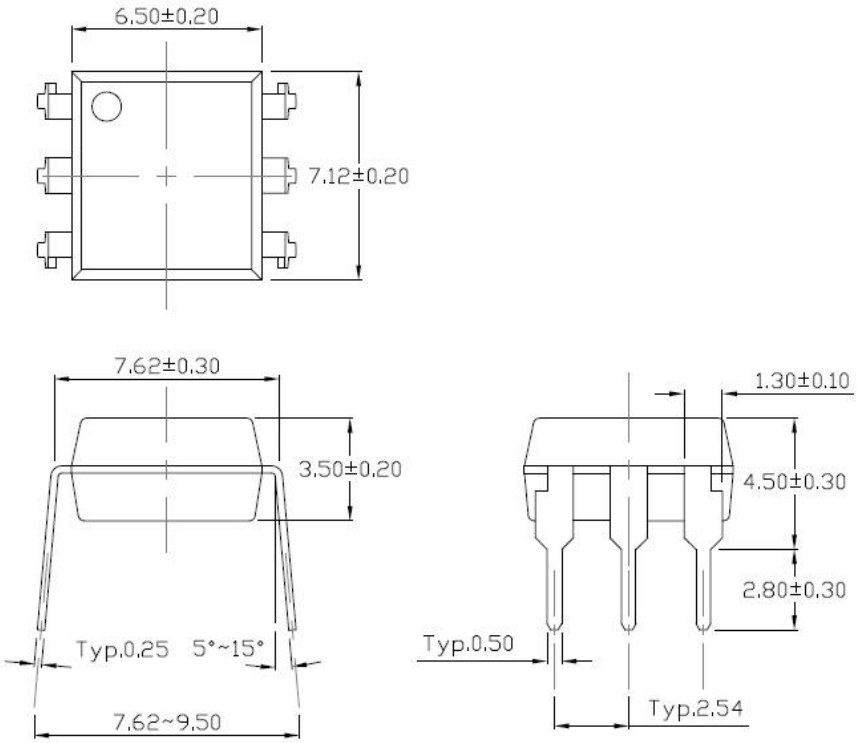
Fig.18 Waveforms of dV/dt



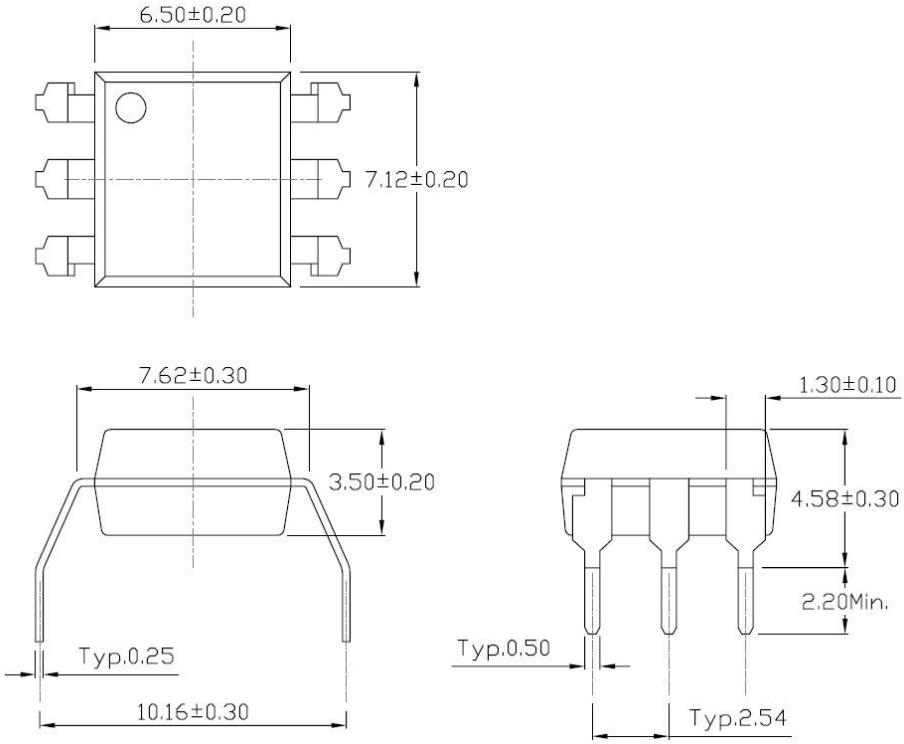
$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard DIP – Through Hole (DIP Type)

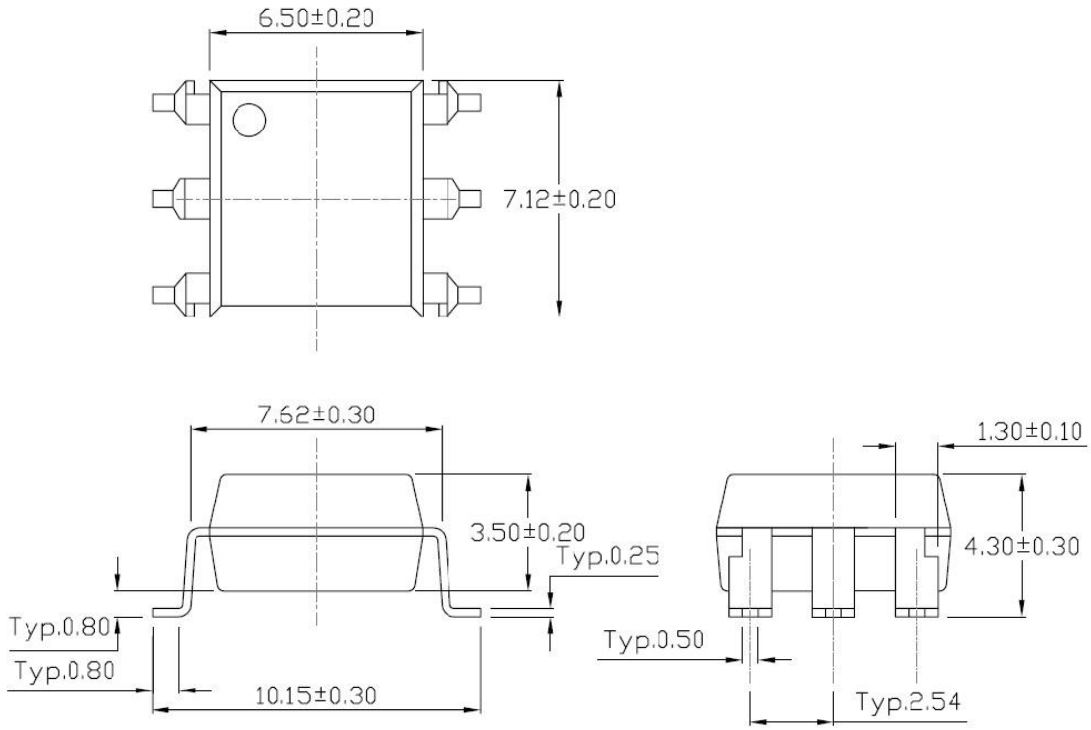


Gullwing (400mil) Lead Forming – Through Hole (M Type)

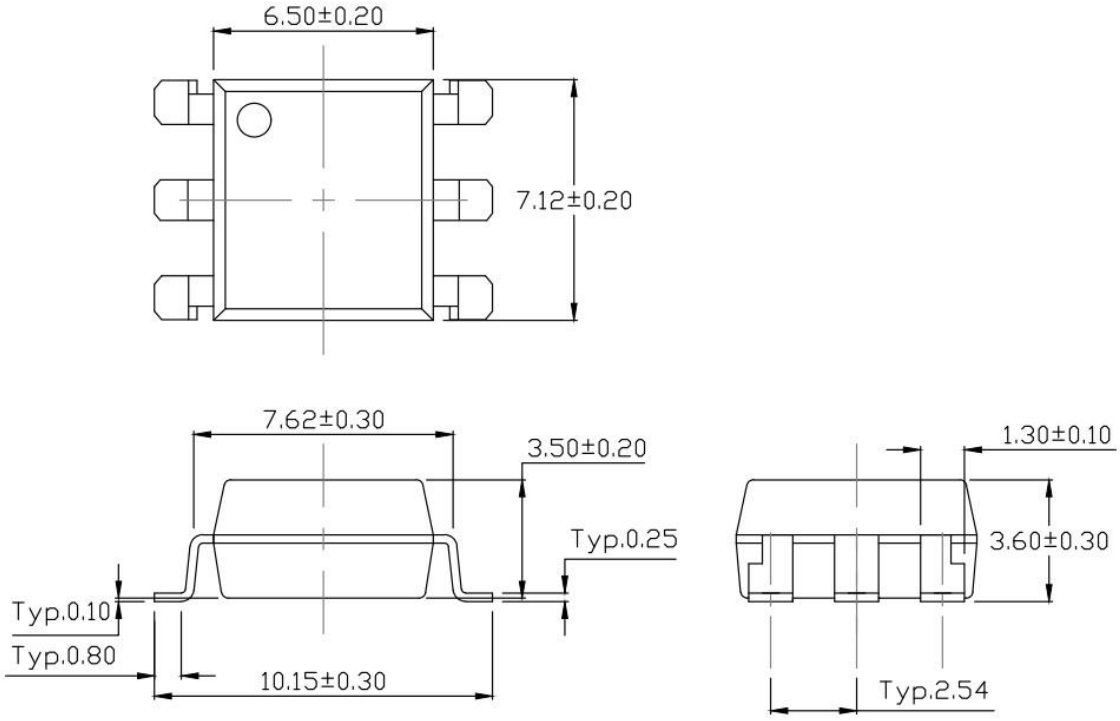


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming (S Type)

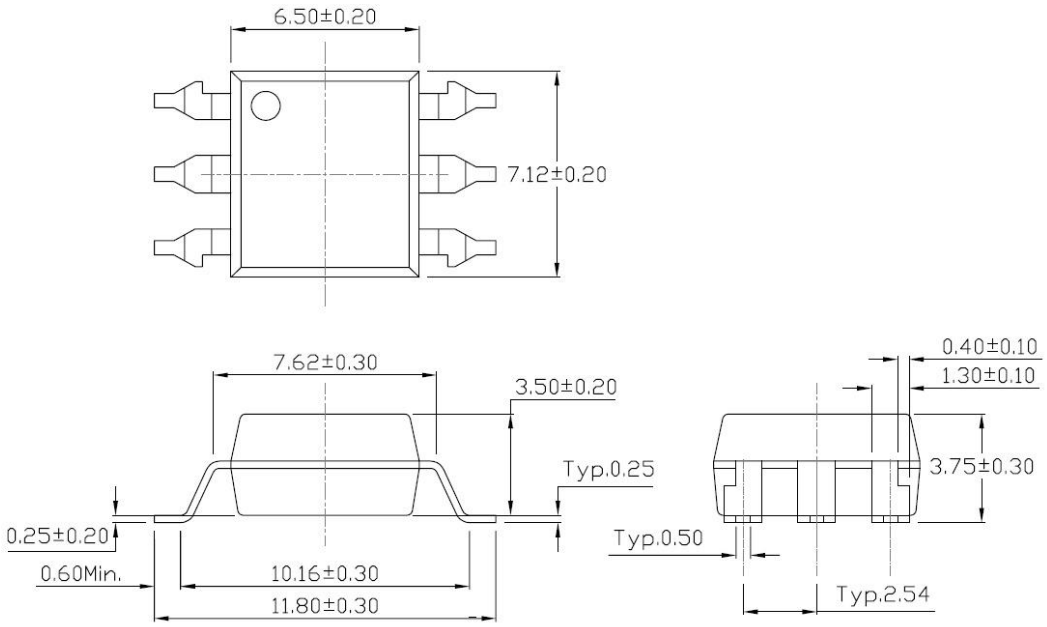


Surface Mount (Low Profile) Lead Forming (SL Type)



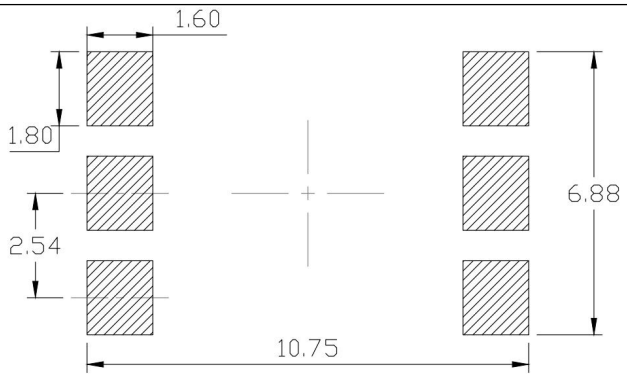
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount (Low Profile) Lead Forming (SLM Type)

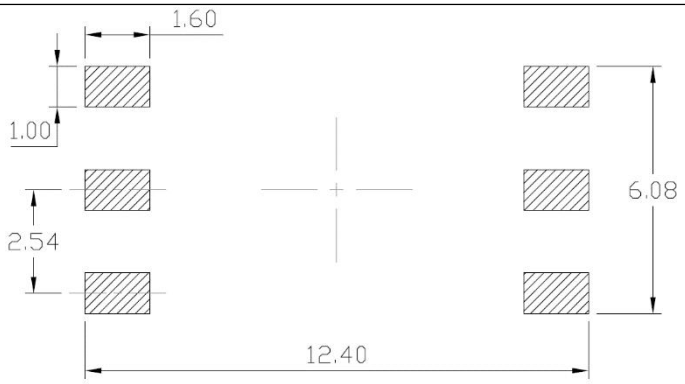


RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

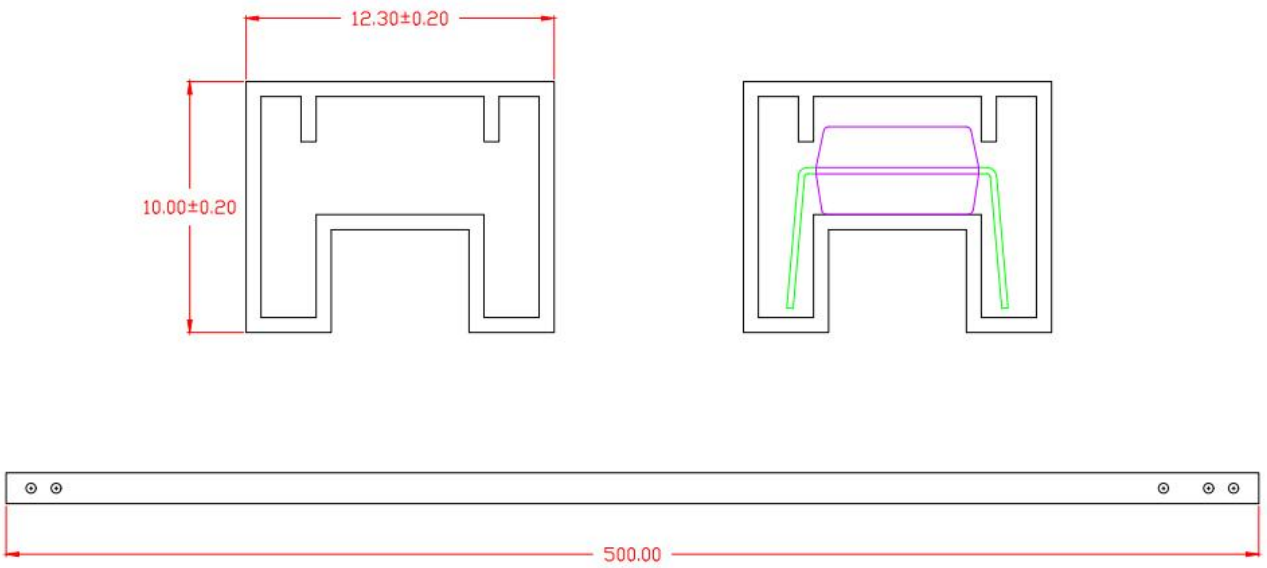


Surface Mount (Gullwing) Lead Forming

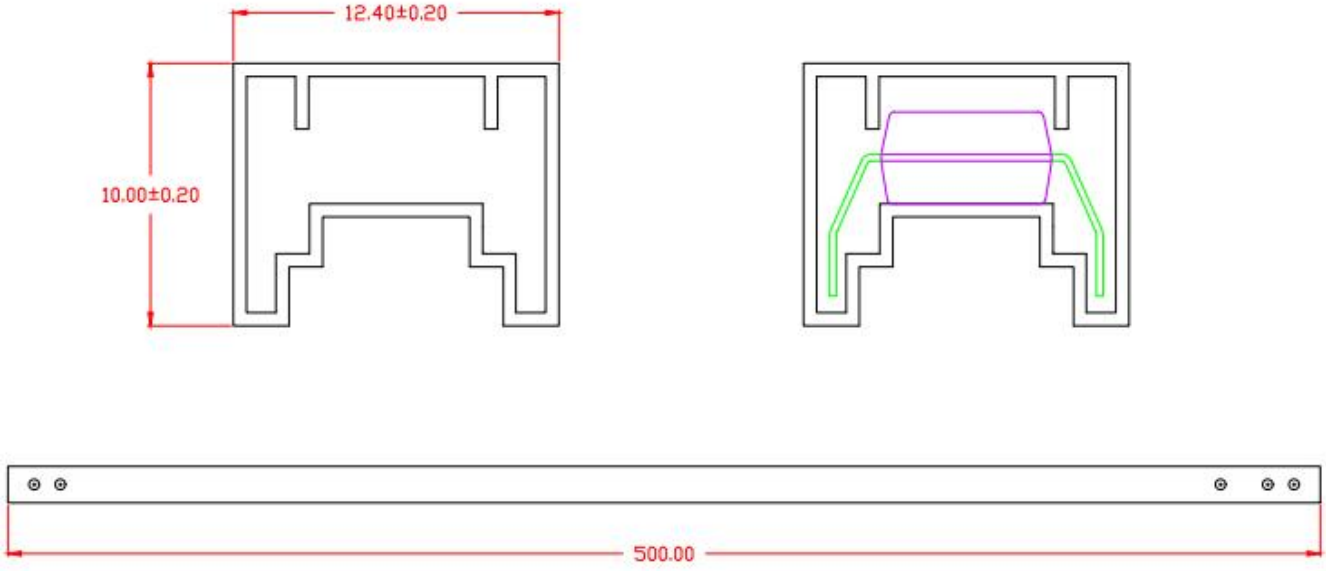


TUBE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Standard DIP

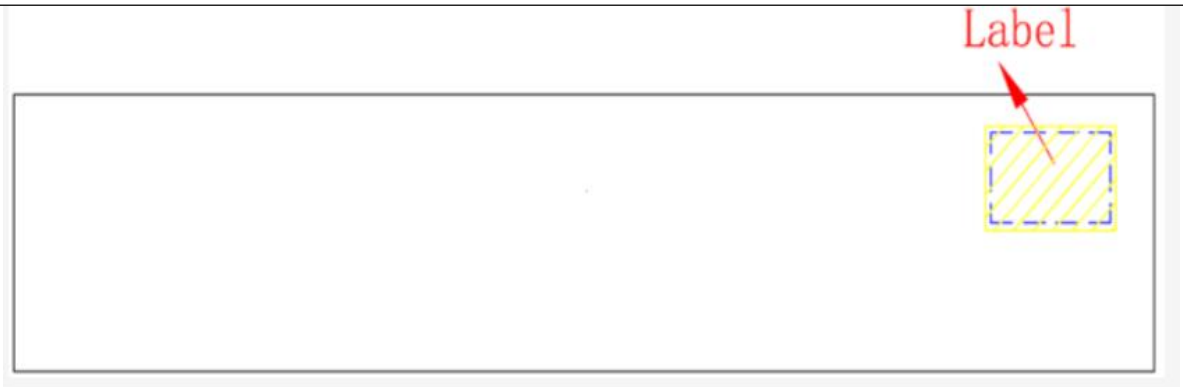


Option M



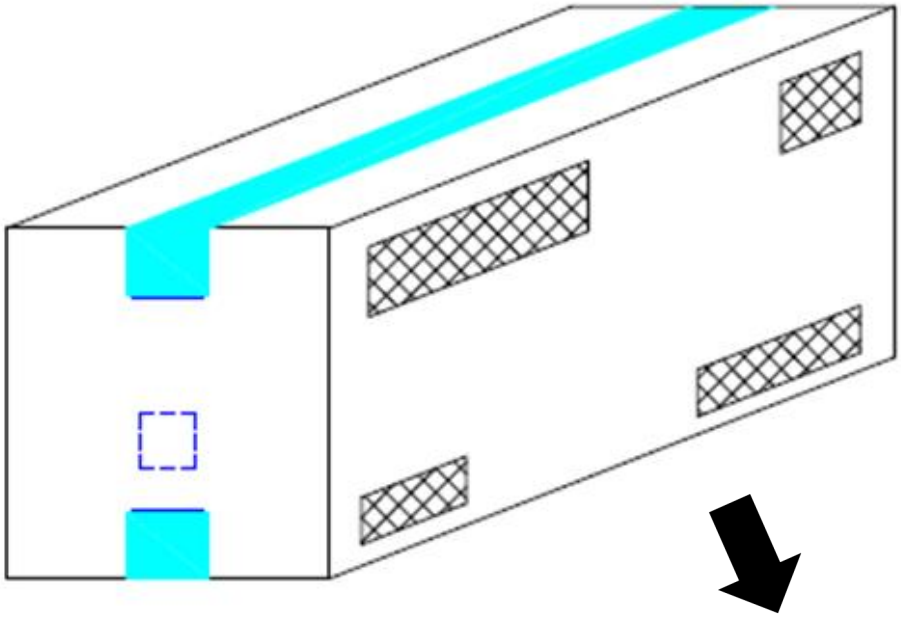
BOX SPECIFICATIONS (Tube Type)

Inner Box



L x W x H = 52.5cm x 10.7cm x 4.7cm

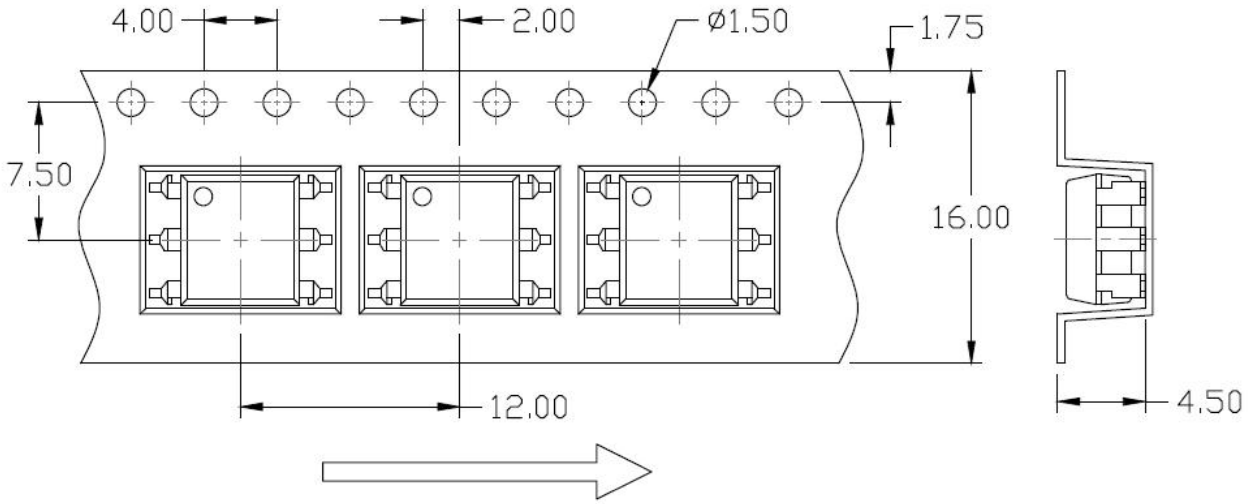
Outer Box



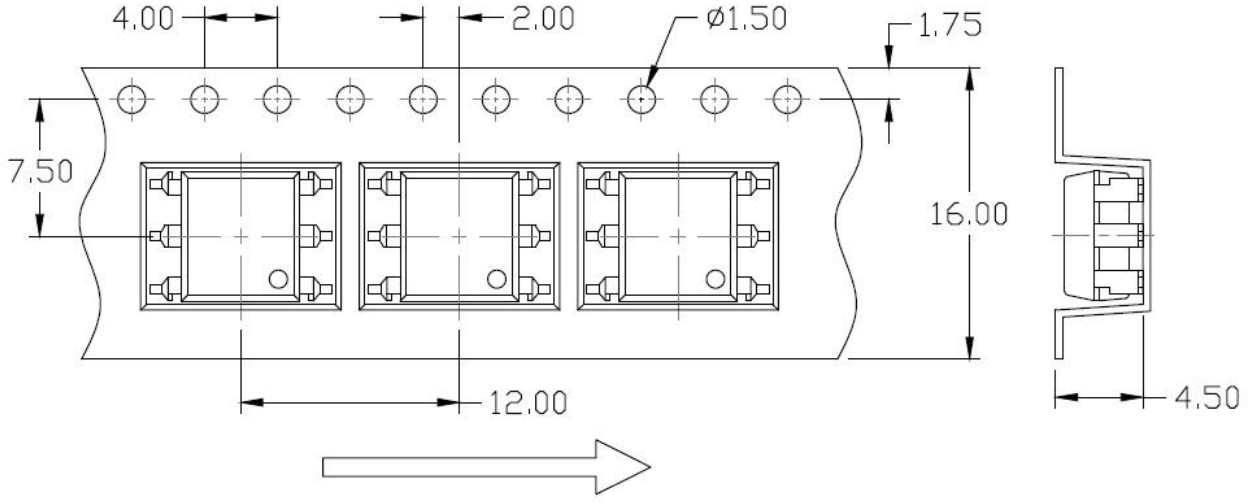
L x W x H = 53.5cm x 23.5cm x 25.5cm

CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1)

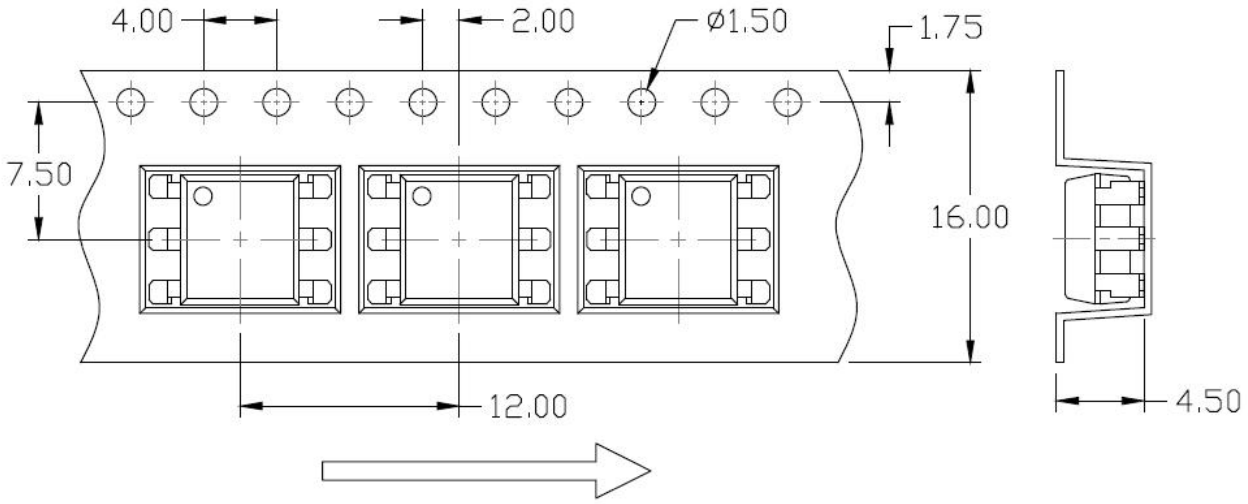


Option S(T2)

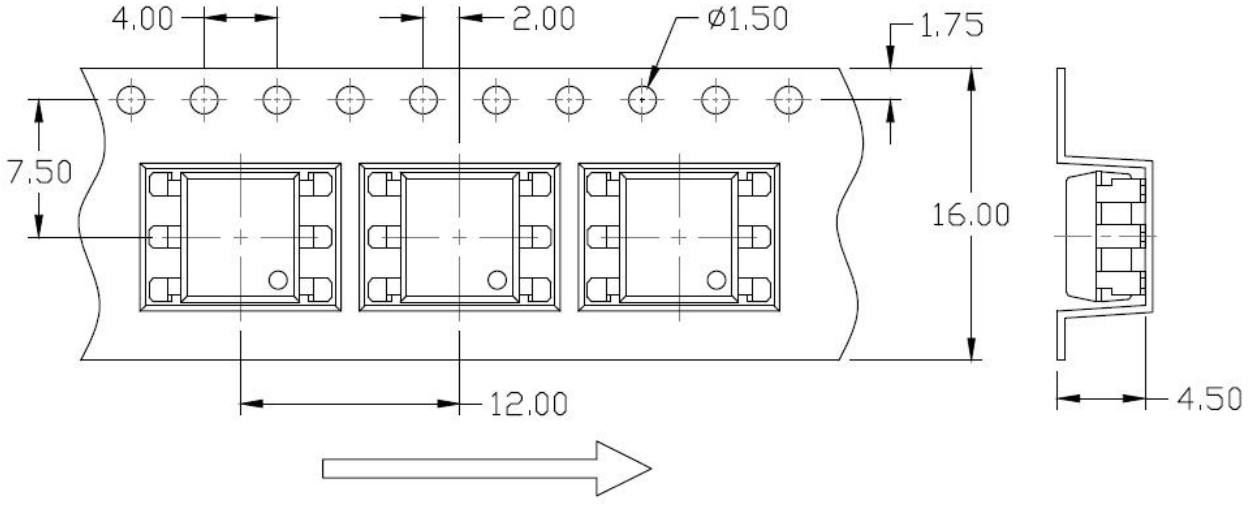


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option SL(T1)

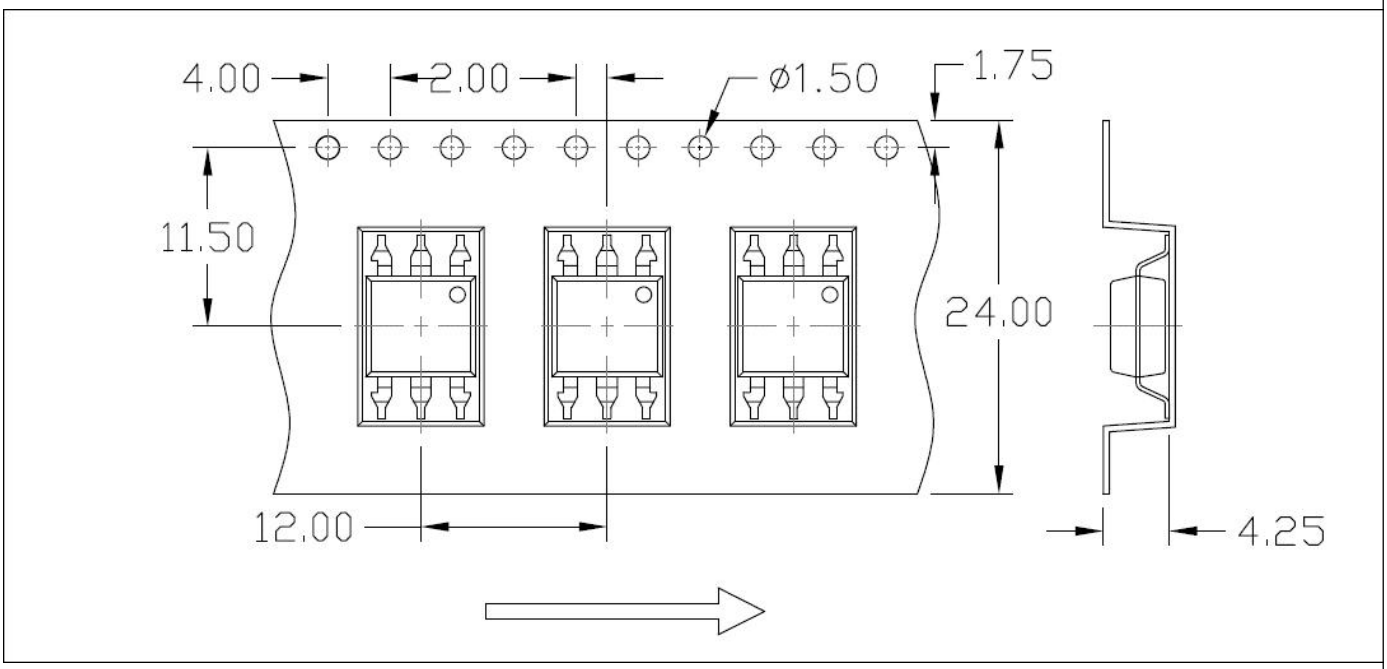


Option SL(T2)

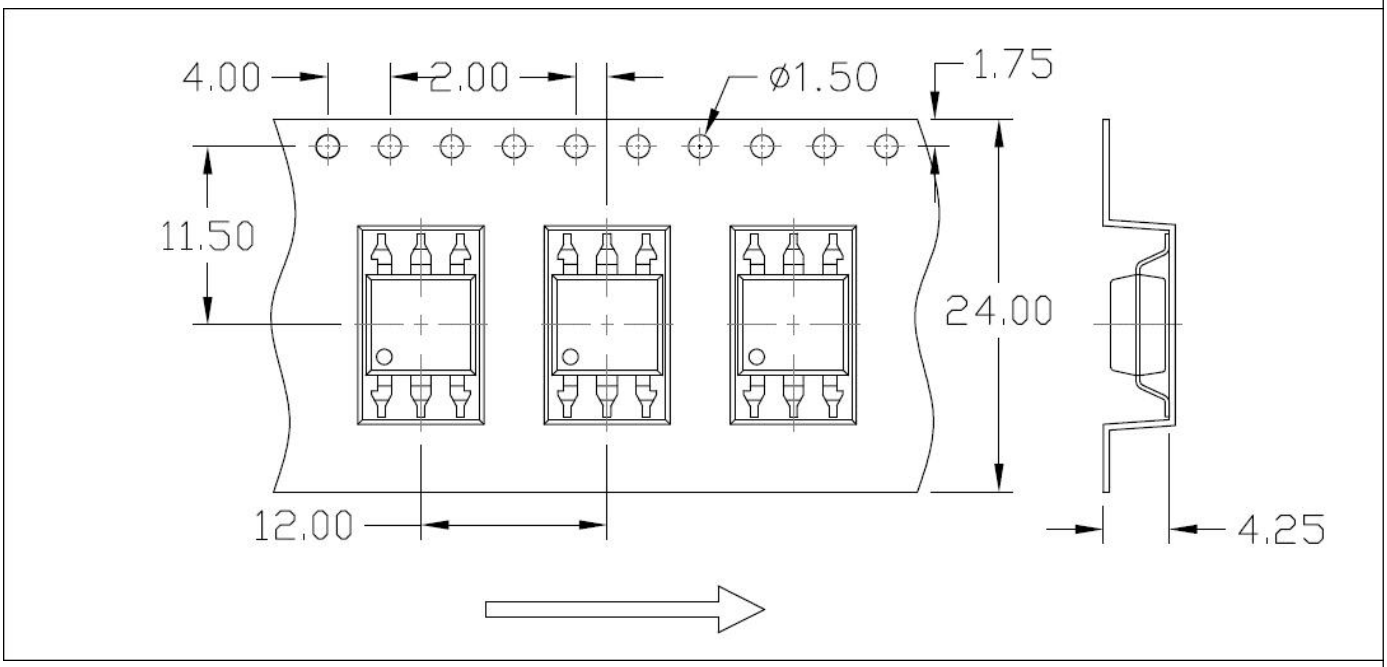


Carrier Tape Specifications (Dimensions in mm unless otherwise stated)

Option SLM(T1)

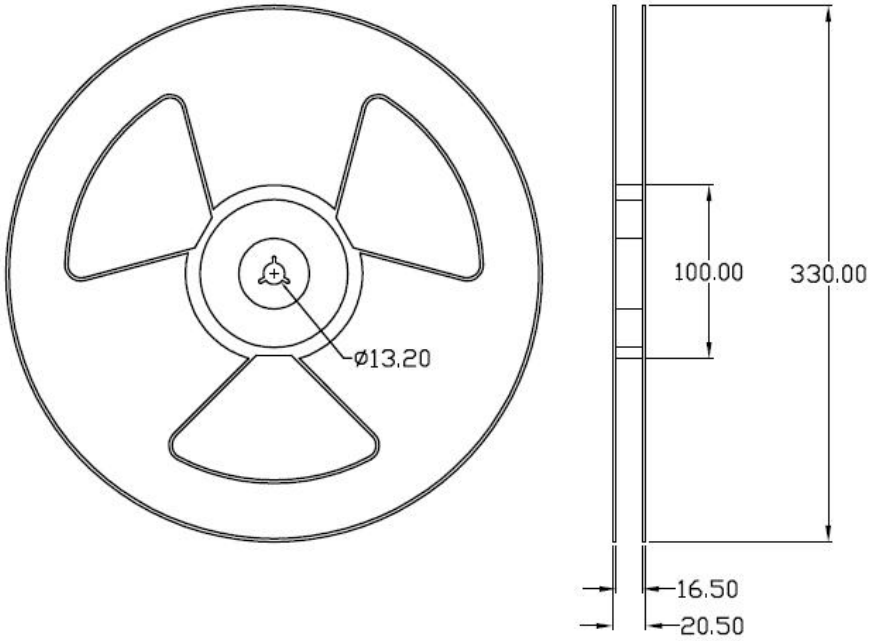


Option SLM(T2)

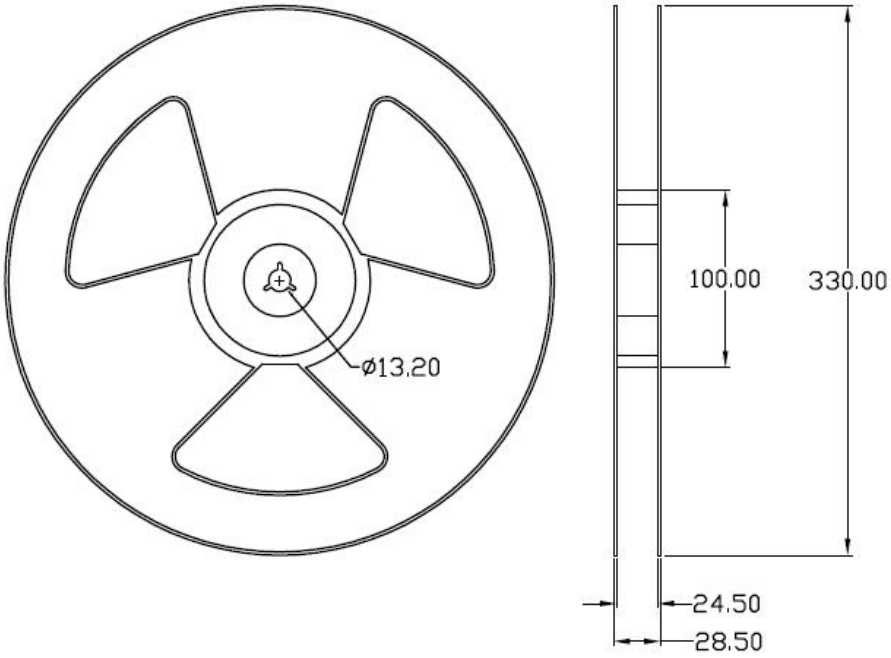


REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S & Option SL

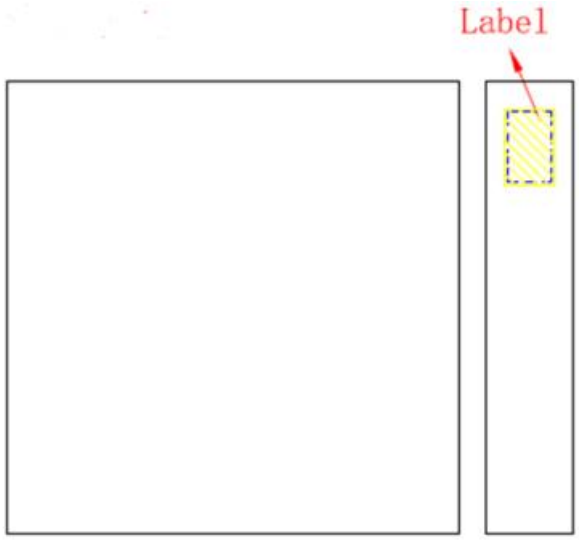


Option SLM



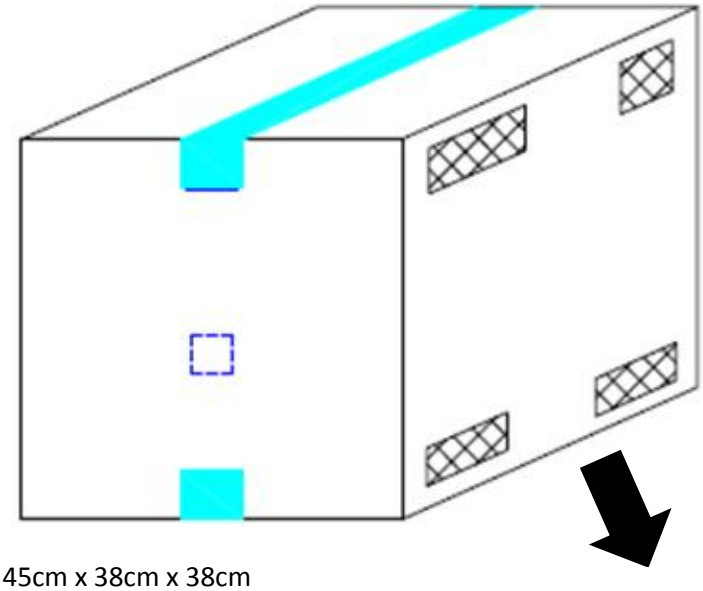
BOX SPECIFICATIONS (Reel Type)

Inner Box

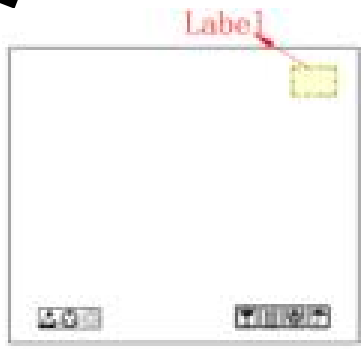


- L x W x H = 36cm x 36cm x 6.9cm

Outer Box

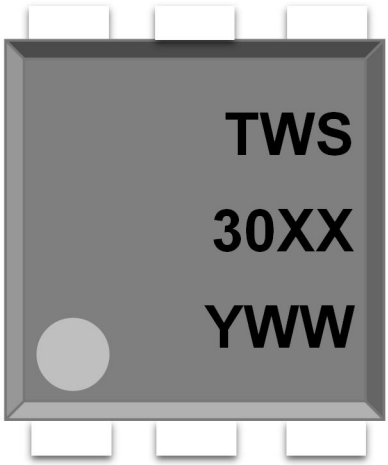


- Option1：L x W x H = 45cm x 38cm x 38cm
- Option2：L x W x H = 39cm x 38cm x 38cm



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



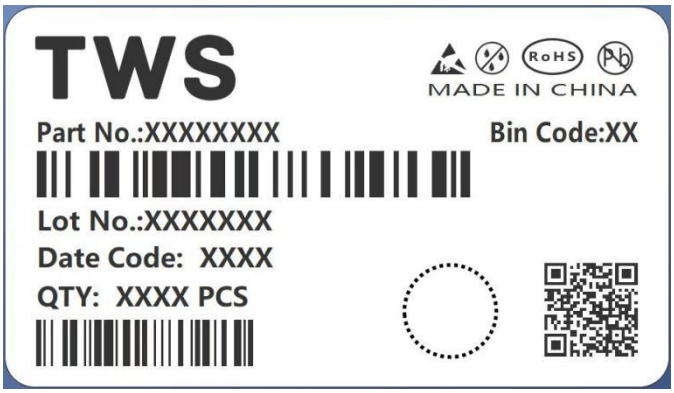
TWS : Company Abbr.
30XX : Part Number & Rank
Y : Fiscal Year
WW : Work Week

ORDERING INFORMATION

TWS30XX(Y)(Z)-G

TWS – Company Abbr.
30XX – Part Number
(31/32/33/41/42/43/61/62/63/81/82/83)
Y – Lead Form Option (M/S/SL/SLM/None)
Z – Tape and Reel Option (T1/T2)
G – Green Option (G or None)

LABEL INFORMATION

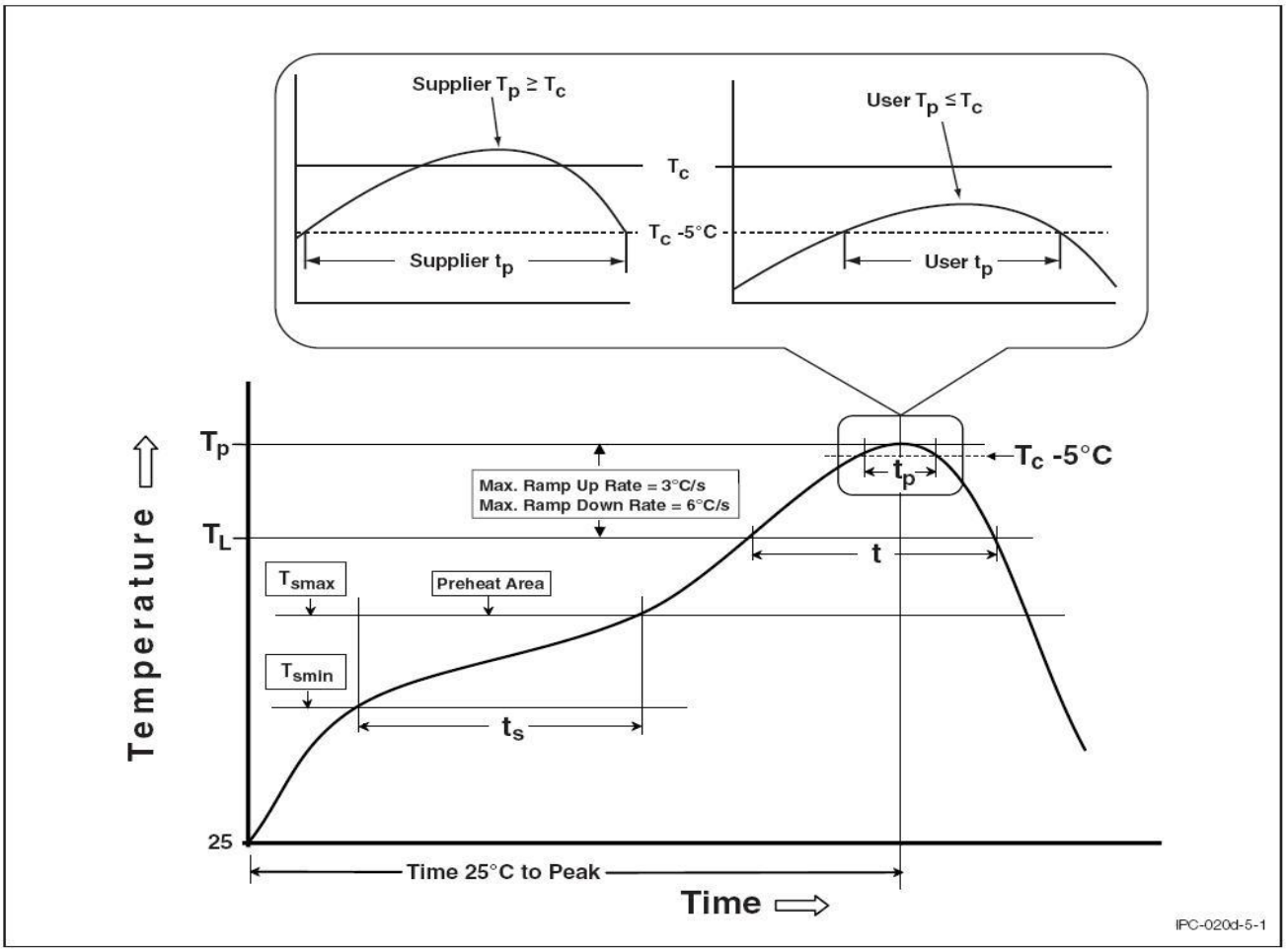


Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity – Outer box
None	65 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 20.8k Units
M	65 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 20.8k Units
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SLM(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SLM(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units

REFLOW INFORMATION

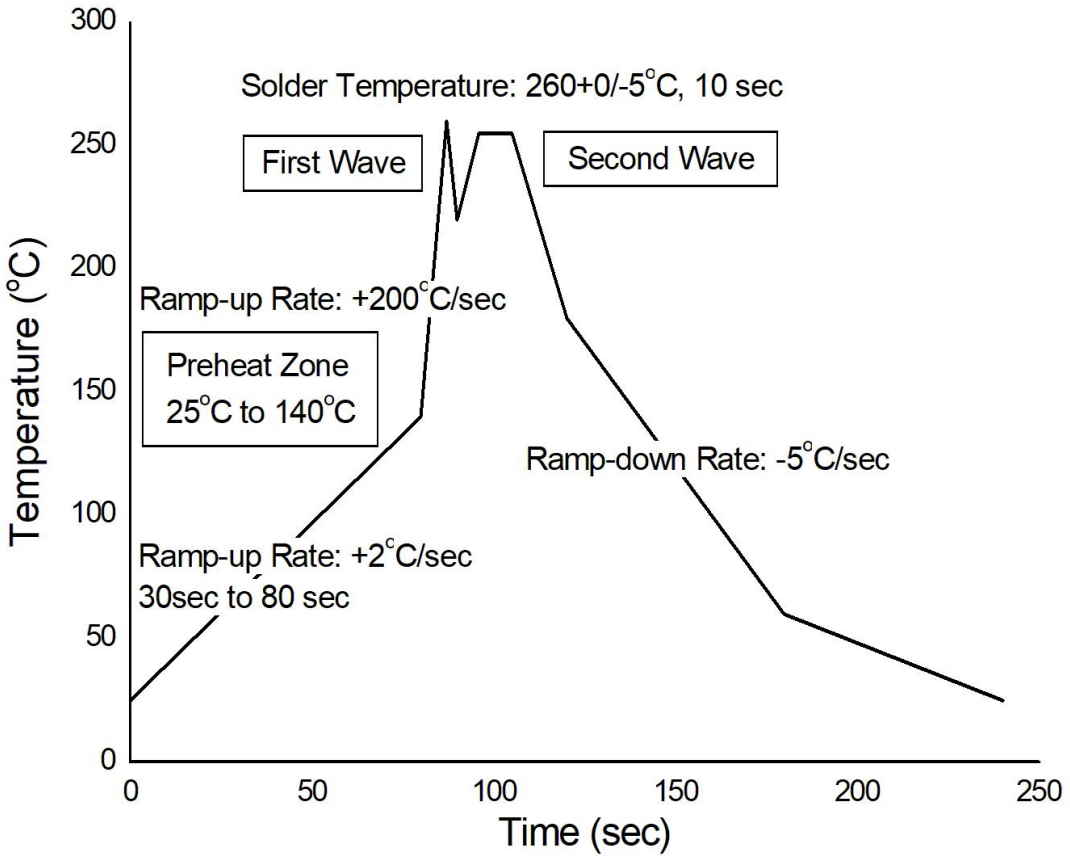
REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

TEMPERATURE PROFILE OF SOLDERING

WAVE SOLDERING (JESD22-A111 COMPLIANT)



HAND SOLDERING BY SOLDERING IRON

Soldering Temperature	380+0/-5°C
Soldering Time	3 sec max.

- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.

DISCLAIMER

- TWS is continually improving the quality, reliability, function and design. TWS reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- TWS makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, TWS disclaims (a) any and all liability arising out of the application or use of any product, (b) any and all liability, including without limitation special, consequential or incidental damages, and (c) any and all implied warranties, including warranties of fitness for particular
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact TWS sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify TWS's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.